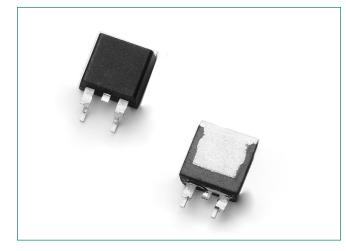


MAC4DHM



Description

The MAC4DHM is designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

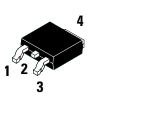
Features

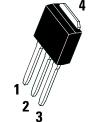
- Small Size Surface Mount DPAK Package
- Passivated Die for Reliability and Uniformity
- Four-Quadrant Triggering
- Blocking Voltage to 600 V
- On-State Current Rating of 4.0 A RMS at 93°C
- Low Level Triggering and Holding Characteristics
- Epoxy Meets UL 94 V-0 @ 0.125 in

P0

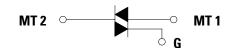
- ESD Ratings: Human Body Model, 3B > 8000 V Machine Model, C > 400V
- Lead–Free Packages are Available

Pin Out





Functional Diagram



Maximum Ratings (T = 25°C unless otherwise noted

č (1)			
Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_{\rm J}$ = -40° to 110°C)	V _{drm} , V _{rrm}	600	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_{\rm c}$ = 93°C)	I _{T (RMS)}	4.0	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _c = 110°C)	I _{TSM}	40	А
Circuit Fusing Consideration (t = 8.3 msec)	l²t	6.6	A ² sec
Peak Gate Current (Pulse Width \leq 20 µsec, T _c = 108°C)	I _{GM}	4.0	А
Peak Gate Power (Pulse Width \leq 10 µsec, T _c = 108°C)	P _{gM}	2.0	W
Peak Gate Voltage (Pulse Width \leq 20 µsec, $_{\rm c}$ T= 93°C)	V _{GM}	5.0	V
Average Gate Power (t = 8.3 msec, T_c = 108°C)	P _{G(AV)}	1.0	W
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the

Recommended Operating Conditions may affect device reliability. 1. V_{DBM} and V_{RBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

	Rating	Symbol	Value	Unit
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient Junction-to-Ambient ^(Note 2)	Re _{JC} Re _{JA} Re _{JA}	3.5 88 80	°C/W
Maximum Lead Temperature for Solde 10 seconds	TL	260	°C	

2. These ratings are applicable when surface mounted on the minimum pad sizes recommended.

3. 1/8" from case for 10 seconds.

Electrical Characteristics - OFF (T = 25°C unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Мах	Unit
Peak Repetitive Blocking Current	T ₁ = 25°C	I _{DRM} ,	-	-	0.01	mA
$(V_{D} = V_{DRM} = V_{RRM}; \text{ Gate Open})$	$T_{J} = 110^{\circ}C$	I _{RRM}	-	-	2.0	mA

Electrical Characteristics - ON (T, = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic				Min	Тур	Max	Unit
Peak On-State Voltage (Note 4) ($I_{TM} = \pm 6$.	0 A)		V _{TM}	-	1.3	1.6	V
	MT2(+), G(+)		_	1.8	5.0		
Gate Trigger Current (Continuous dc)	MT2(+), G(-)		_	2.1	5.0	mA	
$(V_{\rm p} = 12 \text{ V}, \text{ R}_{\rm l} = 100 \Omega)$		MT2(-), G(-)	GT	_	2.4	5.0	mA
(1) 12 () 1) 100 11)	MT2(-), G(+)		_	4.2	10		
Holding Current ($V_p = 12 \text{ V}$, Gate Open, Initiating Current = ±200 mA))				-	1.5	15	mA
Gate Non-Trigger Voltage (Continuous dc) – ($V_p = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 110^{\circ}\text{C}$) All Four Quadrants			V _{gD}	0.1	0.4	-	V
	$(V_{\rm D} = 12 \text{ V}, I_{\rm G} = 5.0 \text{ mA})$	MT2(+), G(+)		-	1.75	10	mA
Latabing Current	$(V_{\rm D} = 12 \text{ V}, I_{\rm G} = 5.0 \text{ mA})$	MT2(+), G(-)		-	5.2	10	
Latching Current	$(V_{\rm D} = 12 \text{ V}, I_{\rm G} = 5.0 \text{ mA})$	MT2(-), G(-)		-	2.1	10	
	$(V_{\rm D} = 12 \text{ V}, \text{ I}_{\rm G} = 10 \text{ mA})$	MT2(-), G(+)		-	2.2	10	
	MT2(+), G(+)			0.5	0.62	1.3	
Gate Trigger Voltage	MT2(+), G(-)	N	0.5	0.57	1.3		
(Continuous dc) ($V_p = 12 V, R_i = 100 \Omega$)		MT2(-), G(-)	V _{gt}	0.5	0.65	1.3	V
		MT2(-), G(+)		0.5	0.74	1.3	

4. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

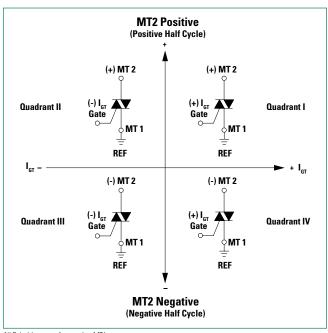


Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current ($V_p = 200 V$, $I_{TM} = 1.8 A$, Commutating dv/dt = 1.0 V/µsec, $T_J = 110^{\circ}C$, f = 250 Hz, CL = 5.0 µfd, LL = 80 mH, RS = 56 Q, CS = 0.03 µfd) With snubber see Figure 11	(dl/dt)c	-	3.0	_	A/ms
Critical Rate of Rise of Off-State Voltage ($V_p = 0.67 \times V_{DRM'}$ Exponential Waveform, Gate Open, $T_j = 110^{\circ}$ C)	dV/dt	20	-	-	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current





All Polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used

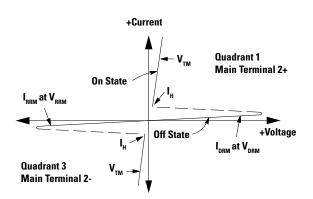




Figure 1. Typical RMS Current Derating

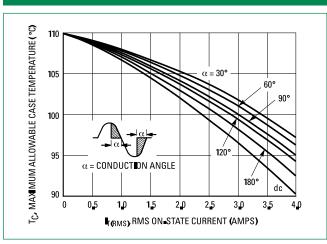


Figure 3. On–State Characteristics

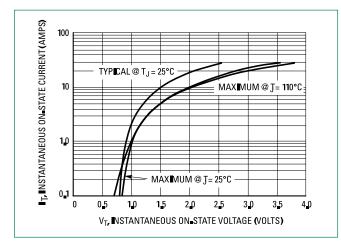


Figure 5. Typical Gate Trigger Current vs, Junction Temperature

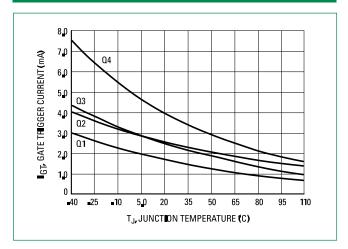


Figure 2. On-State Power Dissipation

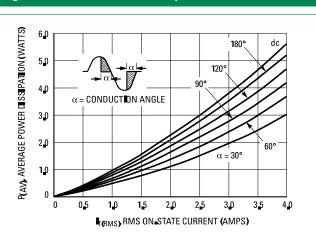


Figure 4. Transient Thermal Response

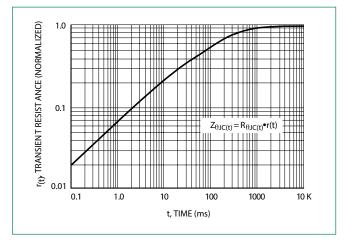
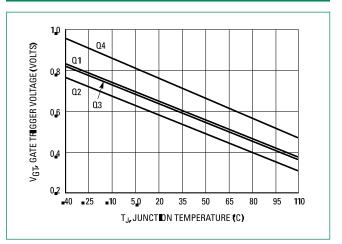
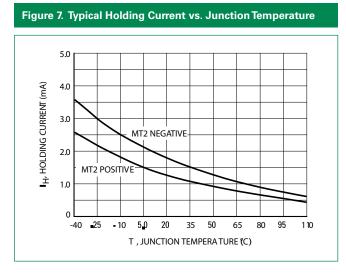


Figure 6. Typical Gate Trigger Voltage vs. Junction Temperature







1000

GATE-MT1 RESIST ANCE (OHMS)

Figure 9. Exponential Static dv/dt vs.

MAC4DHM

40

35

25

20 15

10

5

100

জ 30

STATIC dv/dt (Ŋ

Gate-MT1 Resistance, MT2(+)

Figure 8. Typical Latching Current vs. Junction Temperature

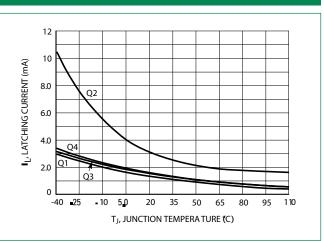


Figure 10. Exponential Static dv/dt vs. Gate-MT1 Resistance, MT2(-)

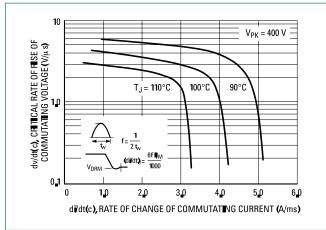
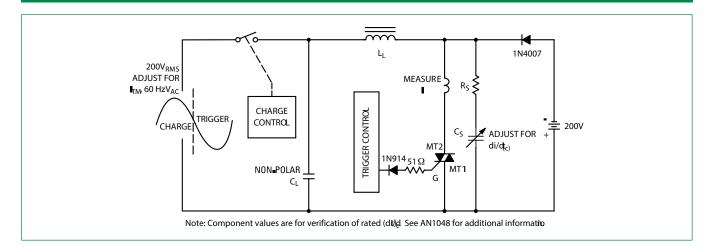


Figure 11. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

10K

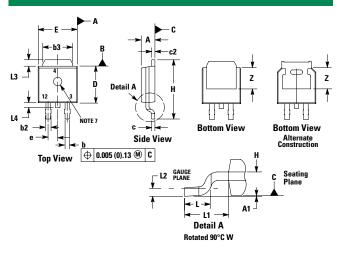
 $V_{D} = 400V$

 $T_{J} = 110^{\circ}C$

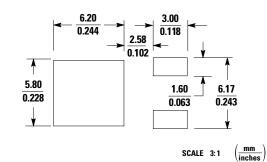




Dimensions



Soldering Footprint



Dim	Dim Inches			Millimeters			
Dim	Min	Max	Min	Max			
Α	0.087	0.094	2.20	2.40			
A1	0.000	0.005	0.00	0.12			
b	0.022	0.030	0.55	0.75			
b2	0.026	0.033	0.65	0.85			
b3	0.209	0.217	5.30	5.50			
C	0.019	0.023	0.49	0.59			
c2	0.019	0.023	0.49	0.59			
D	0.213	0.224	5.40	5.70			
E	0.252	0.260	6.40	6.60			
е	0.0	91	2.3	30			
Н	0.374	0.406	9.50	10.30			
L	0.058	0.070	1.47	1.78			
L1	0.1	14	2.	90			
L2	0.019	0.023	0.49	0.59			
L3	0.053	0.065	1.35	1.65			
L4	0.028	0.039	0.70	1.00			
Z	0.154	-	3.90	-			

O. 134
O. 134
O. 104

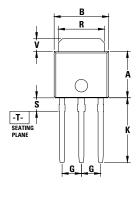


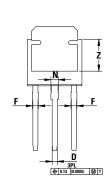
Dimensions

DPAK-3 Case 369D-01 Issue B

T0251-3L POD

E



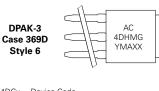


Part Marking System









AC4DCx =Device Code x =D, M, or N X M A XX G =Year =Month =Assembly Site =Lot Serial Code

DPAK-3

Case 369C

Style 6

=P	h-	Fr	00	Pa	0	i	2	20	
	D -		66	10	i C	r	ay	40	

Dim	Inc	hes	Millin	meters		
Dim	Min	Max	Min	Max		
Α	0.213	0.224	5.40	5.70		
В	0.252	0.260	6.40	6.60		
С	0.087	0.094	2.20	2.40		
D	0.024	0.030	0.60	0.75		
E	0.022	0.026	0.55	0.65		
F	0.023	0.031	0.58	0.78		
G	0.091	TYP.	2.30 TYP.			
н	0.046	0.050	1.18	1.28		
J	0.019	0.023	0.49	0.59		
К	0.291	0.315	7.40	8.00		
N	0.031	0.039	0.78	0.98		
R	0.209	0.217	5.30	5.50		
S	0.063	B TYP.	1.60	TYP		
v	0.053	0.065	1.35	1.65		
Z	0.150) TYP.	3.80	TYP.		

Н

I. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: INCH. STYLE 6: PIN 1. MT1
MT2

GATE
MT2

Pin Assignment				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	Main Terminal 2			

Ordering Information						
Device	Package Type	Package	Shipping			
MAC4DHM-001	DPAK-3	369D	4000 Units / Box			
MAC4DHM-001G	DPAK-3 (Pb-Free)	369D	4000 Units / Box			
MAC4DHMT4	DPAK-3	369C	2500 / Tape & Reel			
MAC4DHMT4G	DPAK-3 (Pb-Free)	369C	2500 / Tape & Reel			

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